



# **100mm Assembly** BULLKID-DM Digest meeting

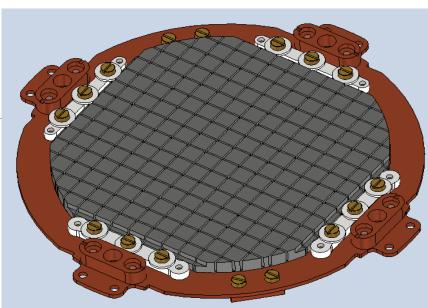
27/03/25

DANIELE PASCIUTO on behalf of the group

## The prototype

Main characteristics:

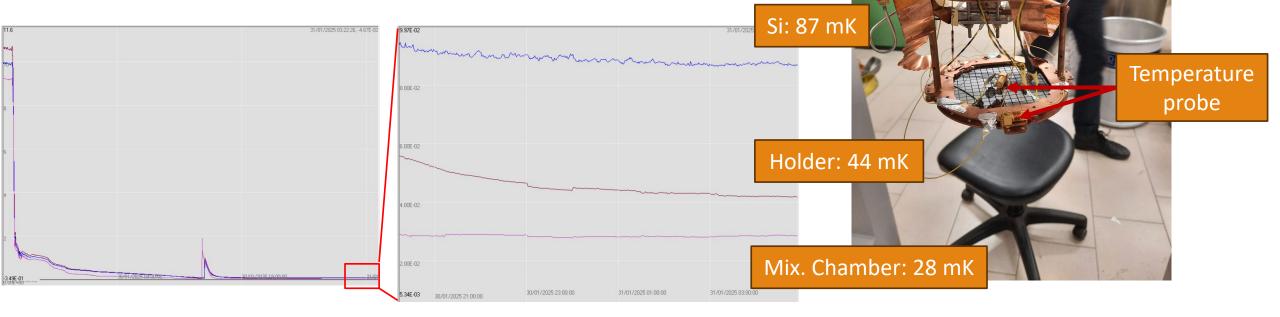
- Minimize materials with impurities (e.g. Cu)
- Optimize thermal contact between the holder and the silicon
- Referable and reproducible stackable structure (16 units ok!)
- Optimizing cost

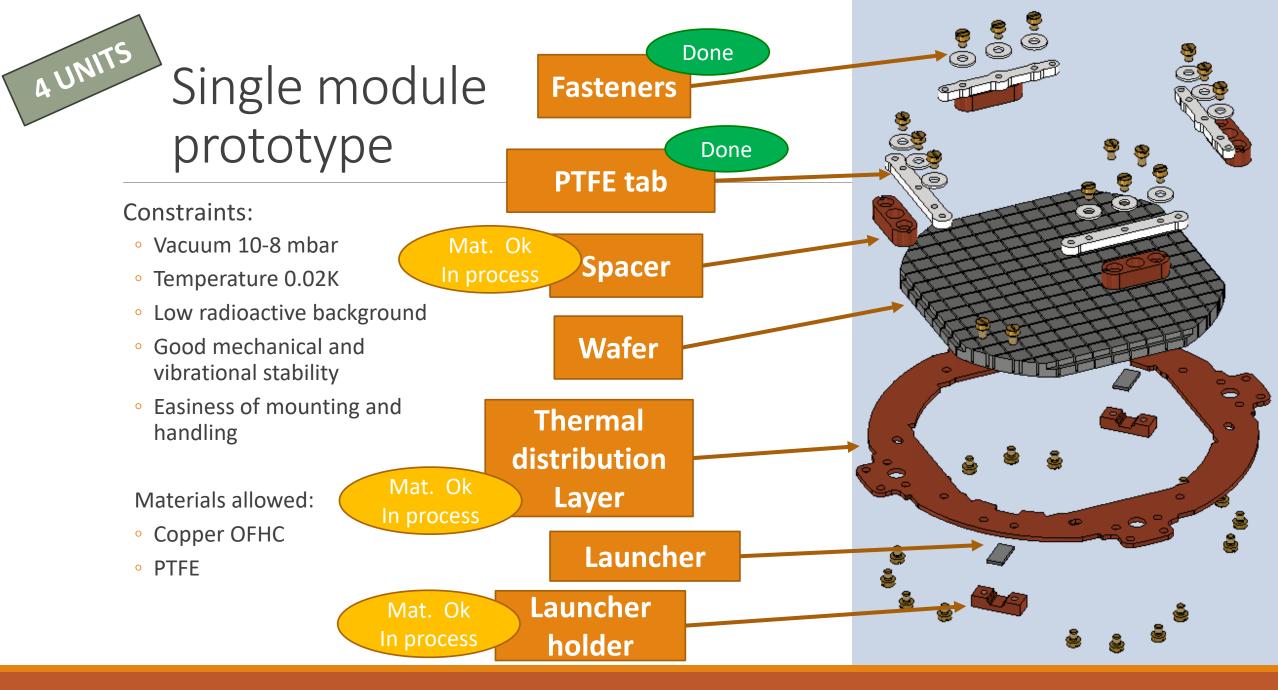




#### Thermal Test @INFN-Sapienza

- Two temperature sensors mounted (KID & Holder)
- The holder prototype has been cooled down up to 44mK
- Both holder and Si temperatures trend follow MC cooling
- No breaking occurred during cooling and heating

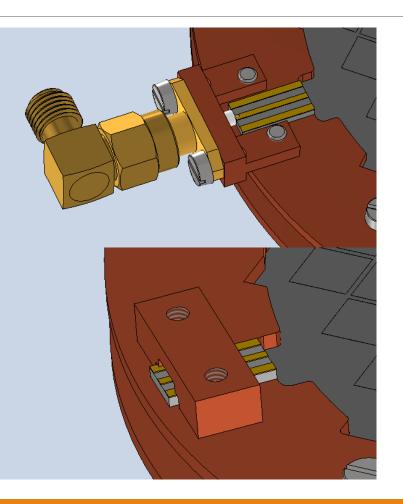




#### Launcher status

- 1. Temporary solution Use of SMA connector
  - Suitable for mounting and dismounting
  - X More components
  - XMuch more space required
  - Roger material
- 2. Upgraded solution **soldered coaxial cable** 
  - Silicium material

Both holders are in process of manufacturing



## 3-Module stack

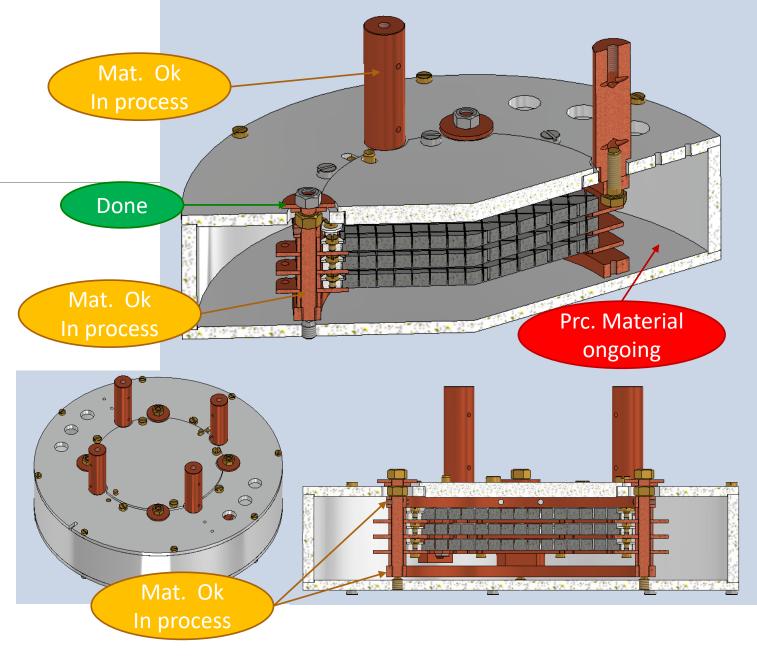
Pure aluminum (1000 series) vessel for shielding

#### Upper and Lower copper rings

- Stiffer structure for vibrations
- Thermal distributors for cooling

Copper rods for thermal contact with cold plated

Feedthroughs for fibers in the aluminum lid for optical calibration (just a dummy plate in the drawing)



# 3-Module assembling

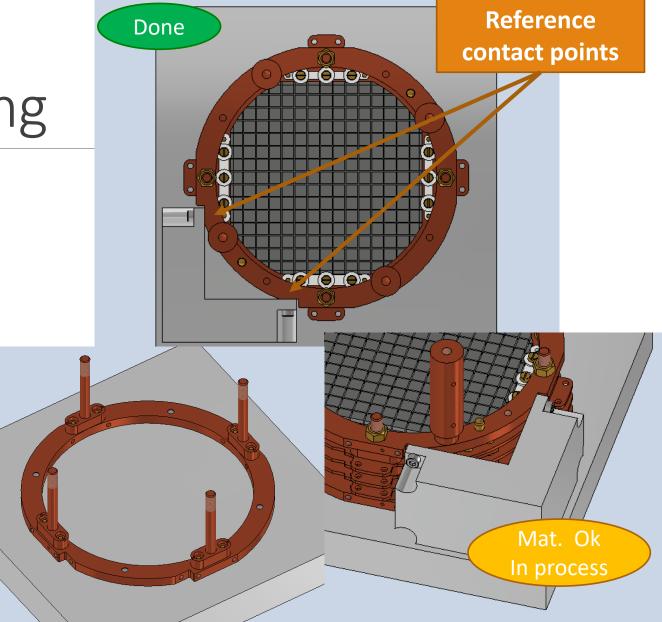
Using an aluminum platform, tight the lower stiffening ring, with the spacers and the columns.

Piling up all the required detector layers (3)

Place the upper stiffening ring with the pillars (for future connecting at the cryostat)

Use a reference square to tight all the layer in referenced position

Untight the detector from the basement and the reference square





#### Thanks for your attention

